



## SSC8027GS7

### P-Channel Enhancement Mode MOSFET

#### ➤ Features

$V_{DS}$	$V_{GS}$	$R_{DS(ON)}$ Typ.	$I_D$
-20V	$\pm 8V$	140m $\Omega$ @-4V5	-2.7A
		190m $\Omega$ @-2V5	
		280m $\Omega$ @-1V8	

#### ➤ Description

The SSC8027GS7 is P-Channel enhancement MOS Field Effect Transistor. Uses advanced trench technology and design to provide excellent RDSON with low gate charge. This device is suitable for use in load switch, electronic cigarette and Battery Isolation.

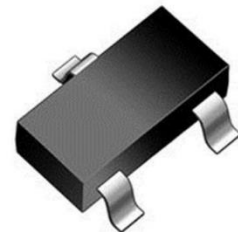
#### ➤ Applications

- Load Switch
- Electronic Cigarette
- Battery Isolation

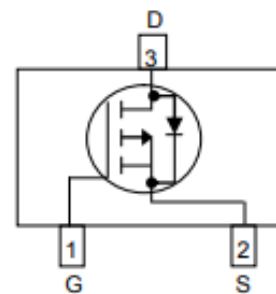
#### ➤ Ordering Information

Device	Package	Shipping
SSC8027GS7	SOT-323	3000/Reel

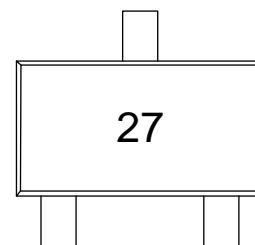
#### ➤ Pin configuration



**SOT-323**



**Pin Configuration (Top View)**



**Marking**



➤ **Absolute Maximum Ratings ( $T_A=25^{\circ}\text{C}$  unless otherwise noted)**

Symbol	Parameter	Ratings	Unit
$V_{DSS}$	Drain-to-Source Voltage	-20	V
$V_{GSS}$	Gate-to-Source Voltage	$\pm 8$	V
$I_D$	Continuous Drain Current <sup>a</sup>	-2.7	A
$I_{DM}$	Pulsed Drain Current <sup>b</sup>	-11	A
$P_D$	Power Dissipation <sup>c</sup>	1.7	W
$T_J$	Operation junction temperature	-55~150	$^{\circ}\text{C}$
$T_{STG}$	Storage temperature range	-55~150	$^{\circ}\text{C}$

➤ **Thermal Resistance Ratings ( $T_A=25^{\circ}\text{C}$  unless otherwise noted)**

Symbol	Parameter	Ratings	Unit
$R_{\theta JA}$	Junction-to-Ambient Thermal Resistance <sup>a</sup>	62	$^{\circ}\text{C}/\text{W}$

Note:

- The value of  $R_{\theta JA}$  is measured with the device mounted on 1 in<sup>2</sup> FR-4 board with 2oz.copper, in a still air environment with  $T_A=25^{\circ}\text{C}$ . The value in any given application depends on the user is specific board design. The power dissipation is based on the  $t \leq 10\text{s}$  thermal resistance rating.
- Repetitive rating, pulse width limited by junction temperature.
- The power dissipation  $P_D$  is based on  $T_{J(MAX)}=150^{\circ}\text{C}$ , using junction-to-case thermal resistance, and is more useful in setting the upper dissipation limit for cases where additional heat sinking is used.

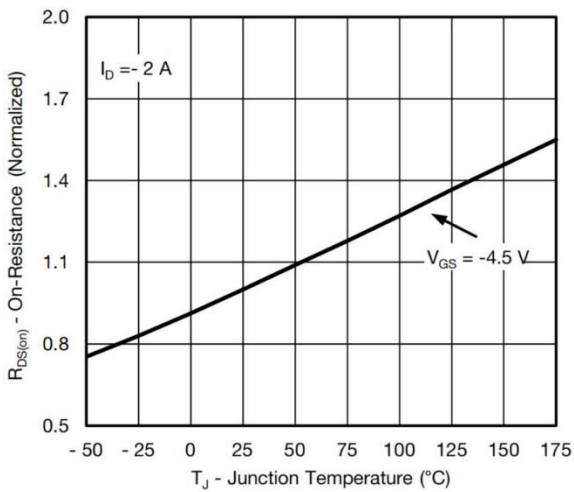
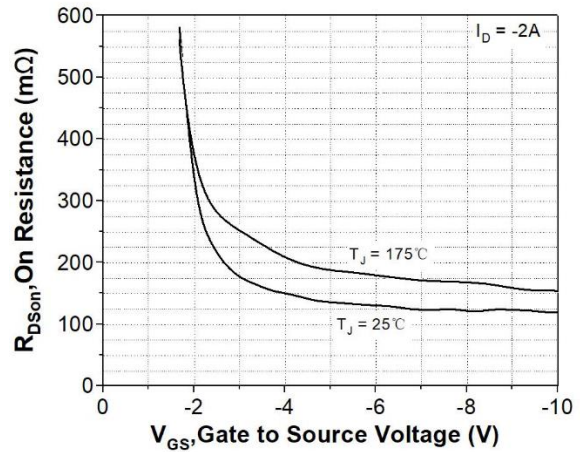
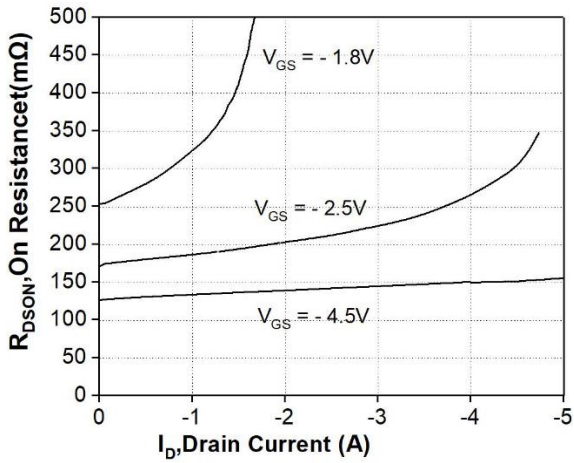
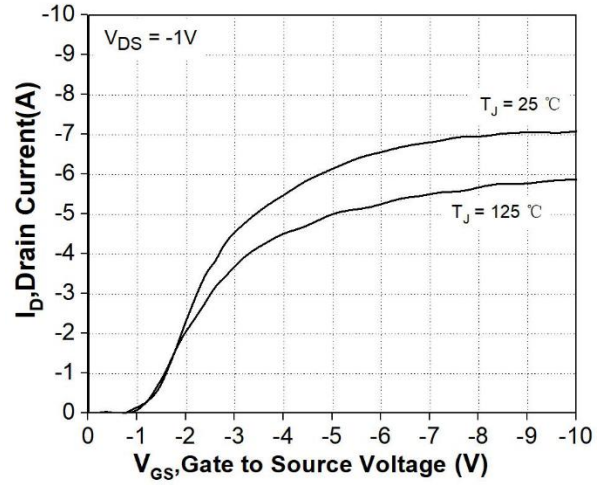
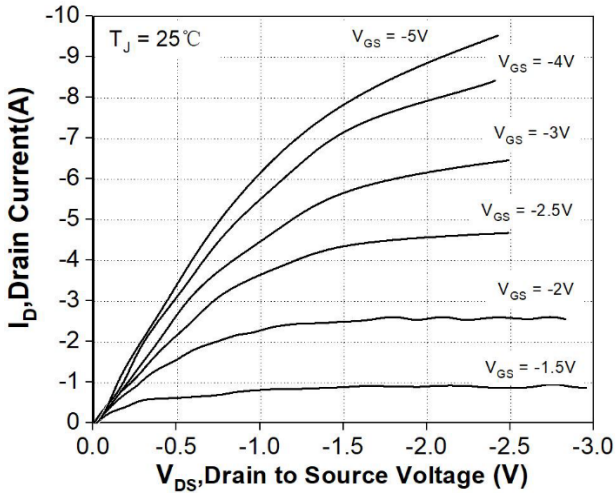


➤ **Electrical Characteristics (T<sub>A</sub>=25°C unless otherwise noted)**

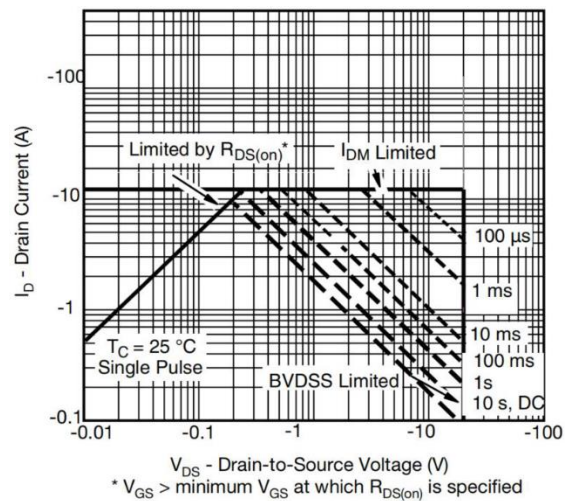
Parameter	Symbol	Test Conditions	Min.	Typ.	Max.	Unit
Drain-Source Breakdown Voltage	V <sub>(BR)DSS</sub>	V <sub>GS</sub> = 0V, I <sub>D</sub> = -250μA	-20			V
Gate Threshold Voltage	V <sub>GS(th)</sub>	V <sub>DS</sub> = V <sub>GS</sub> , I <sub>D</sub> = -250μA	-0.4	-0.75	-1.5	V
Drain-Source On-Resistance	R <sub>DS(on)</sub>	V <sub>GS</sub> = -4.5V, I <sub>D</sub> = -0.45A		140	350	mΩ
		V <sub>GS</sub> = -2.5V, I <sub>D</sub> = -0.35A		190	450	
		V <sub>GS</sub> = -1.8V, I <sub>D</sub> = -0.25A		280	700	
Zero Gate Voltage Drain Current	I <sub>DSS</sub>	V <sub>DS</sub> = -20V, V <sub>GS</sub> = 0V			-1	μA
Gate-Source Leak Current	I <sub>GSS</sub>	V <sub>GS</sub> = ±8V, V <sub>DS</sub> = 0V			±100	nA
Transconductance	G <sub>FS</sub>	V <sub>DS</sub> = -5V, I <sub>D</sub> = -2A		6.6		s
Forward Voltage	V <sub>SD</sub>	V <sub>GS</sub> = 0V, I <sub>S</sub> = -1A		-0.8	-1.3	V
Input Capacitance	C <sub>ISS</sub>	V <sub>DS</sub> = -10V, V <sub>GS</sub> = 0V, f = 1MHz		227		pF
Output Capacitance	C <sub>OSS</sub>			115		
Reverse Transfer Capacitance	C <sub>RSS</sub>			39		
Turn-on Delay Time	T <sub>D(ON)</sub>	V <sub>GS</sub> = -4.5V, V <sub>DS</sub> = -10V, R <sub>L</sub> = 5Ω, R <sub>G</sub> = 3Ω		12		ns
Rise Time	T <sub>r</sub>			6.2		
Turn-off Delay Time	T <sub>D(OFF)</sub>			25		
Fall Time	T <sub>f</sub>			10		
Total Gate Charge	Q <sub>G</sub>	V <sub>GS</sub> = -4.5V, V <sub>DS</sub> = -10V, I <sub>D</sub> = -2A		3.5		nC
Gate to Source Charge	Q <sub>GS</sub>			0.5		
Gate to Drain Charge	Q <sub>GD</sub>			1.3		



➤ **Typical Performance Characteristics ( $T_A=25^\circ\text{C}$  unless otherwise noted)**

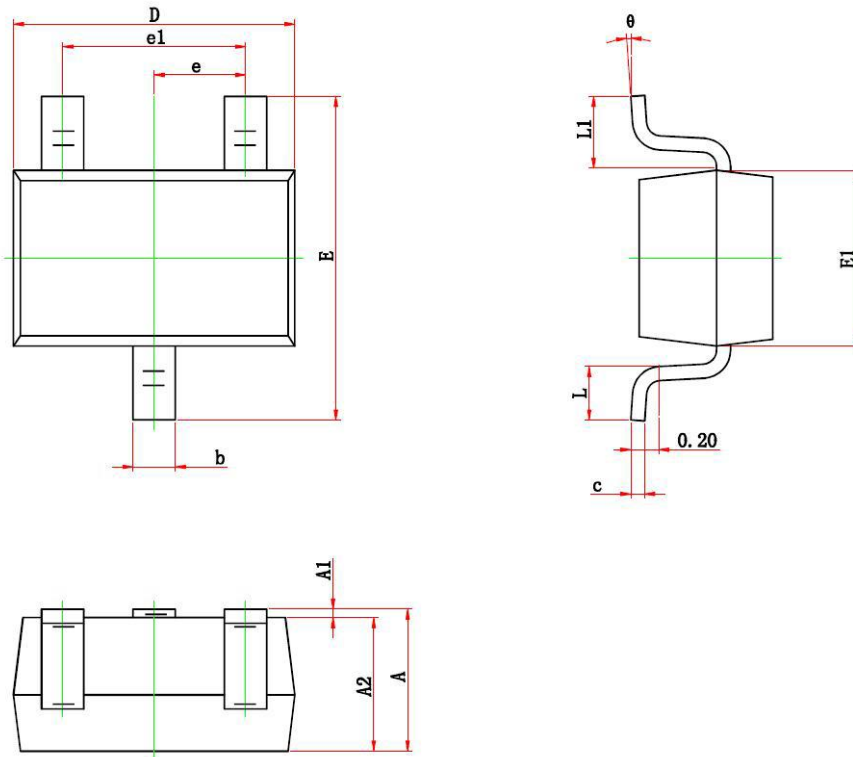


**On-Resistance vs. Junction Temperature**



**Safe Operating Area**

## ➤ Package Information



Symbol	Dimensions In Millimeters		Dimensions In Inches	
	Min.	Max.	Min.	Max.
A	0.900	1.100	0.035	0.043
A1	0.000	0.100	0.000	0.004
A2	0.900	1.000	0.035	0.039
b	0.200	0.400	0.008	0.016
c	0.080	0.150	0.003	0.006
D	2.000	2.200	0.079	0.087
E	2.150	2.450	0.085	0.096
E1	1.150	1.350	0.045	0.053
e	0.650 TYP.		0.026 TYP.	
e1	1.200	1.400	0.047	0.055
L	0.260	0.460	0.010	0.018
L1	0.525 REF.		0.021 REF.	
$\theta$	0°	8°	0°	8°



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